

## Preparation of reactive magnetron sputtered SiC films by RF-RMS technique.

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SiC thin films have been prepared by using the RF reactive magnetron sputtering. The deposition parameters have been varied over a wide range to optimize the quality of the films; substrate temperature from 700-1000°C, Ar/CH<sub>4</sub> composition from 80/20-50/50 and RF-Power 100-200 Watt. The samples have been characterized by X-Ray diffraction, Rutherford backscattering, Perfilometry, FTIR spectroscopy and ellipsometry. The results show that good quality silicon carbide films can be prepared by using RF-RMS technique.

### 1. Introduction

Amorphous silicon carbide (a-Si<sub>1-x</sub>C<sub>x</sub>) is an attractive material from a technological point of view. Its electronic and optical properties make it potentially useful as solar selective coating. In addition, because of its high temperature resistant, wide band gap and high electron saturation velocity of its semiconducting properties, a-Si<sub>1-x</sub>C<sub>x</sub> alloy is a good candidate for stable high-T semiconductor and high power devices[1].

This material has been prepared by various techniques such as chemical vapour deposition (CVD)[2], plasma enhanced chemical vapour deposition (PECVD)[3], reactive magnetron sputtering (RMS)[4], etc. In recent years, an extensive experimental effort has been devoted to the study of a-SiC[5]. However, a complete understanding of the relation between its physical properties and the preparation process is still lacking.

We started work on the preparation of crystalline SiC thin films using the RMS technique after the work of Wahab et. al.[6,7] who reported, for the first time, the preparation of cubic SiC thin films using this technique. We used the same technique and the same preparation conditions as they used but our results are very different. We have obtained amorphous films and have studied the dependency of reactive sputtered films on the deposition parameters. These parameters such as temperature, ratio of argon to methane have been changed over a wide range and a correlation of the deposition parameters with the physical properties of the SiC films is proposed.

### 2. Experiment

The films were grown in a turbomolecular-pumped ultrahigh vacuum sputtering system with a base pressure of  $3 \times 10^{-7}$  torr. The RMS technique was employed in a mixed Ar/hydrocarbon plasma. The system was equipped with a 4 inch magnetron source and the used target material was a high purity (99.999%) electronic grade silicon disc which was clamped against the water-cooled cathode surface. Sputtering was carried out in mixed Ar-CH<sub>4</sub> discharges at different powers of RF. The purity of Ar and CH<sub>4</sub> gases was 99.999%. For this work, the pressure, total gas flow and target to substrate distance were kept constant at 3

mTorr, 10 sccm and 3 cm, respectively. The substrates were pieces of Si(100) wafers which were chemically cleaned prior to the insertion in the vacuum chamber. The substrates were cleaned in NH<sub>4</sub>OH:H<sub>2</sub>O<sub>2</sub>:H<sub>2</sub>O and HCl:H<sub>2</sub>O<sub>2</sub>:H<sub>2</sub>O for 5 minutes each, then rinsed with ionized water. The deposition parameters were varied over the following range:

- RF-Power 100 and 200 Watt
- Gas composition 80/20, 70/30, 40/60 and 50/50 Ar to CH<sub>4</sub> ratio for each value of RF-Power
- Substrate temperature, T<sub>s</sub>=700-1000°C for each set of gas composition

When the substrate temperature was at the required value, CH<sub>4</sub> was introduced to a pressure P<sub>CH<sub>4</sub></sub> of 0.6 mTorr for 10 minutos to carbonize the surface of the silicon. Then the P<sub>Ar</sub> was increased to obtain P<sub>tot</sub>=3.0 mTorr, the pressure maintained throughout the deposition. The discharge was then ignited. The Si target was sputter cleaned for 5-10 minutes. The shutter between the target and substrate prevented deposition of sputtered material on the latter. Subsequently, the shutter was removed and growth initiated at a constant discharge power. Graphite and, in some cases, a 1mm wide strip of silicon, was used to mask the edge of the silicon substrate and in this way a step was formed between the edge of the deposit and the substrate. This step was used to measure the film thickness by a perfilometer.

All the samples have been studied by the X-Ray Diffraction using a Seimans Diffractometer, model D500, of the Institute of Materials Science, IIM. The ion beam analysis, IBA, facilities at the university of Mexico[8] based on a vertical single ended 5.5 MeV Van de Graff Accelerator (in the Institute of physics) films and its associated instrumentation were used to obtain the areal density and the elemental composition of SiC films. The produced spectra being analysed using the RUMP software package[9] developed by Cornell University. The thickness of the films was found using the Gaertner ellipsometer (model L117) and a Dektak IIA perfilometer. For the evaluation of refractive index, the same ellipsometer was used. For the analysis of plasma, an optical emission spectroscopy OES was employed. The monochromator was an Oriol model 77250 machine with a 1200 lines/mm grating usable from 300 to 950 nm.

The optical detector Hamamatsu model R955 side window photomultiplier used in conjunction with a Hamamatsu preamplifier. For optical measurements, a Nicolet model 205 FTIR was employed with a measurement range of 400 to 4000  $\text{cm}^{-1}$

### 3. Results

According to the X-Ray Diffraction data, there is no prominent peak indicating the formation of crystalline SiC films

A typical spectra from RBS is shown in the figure 1. This was used to calculate the silicon to carbon ratio, R, and also used to detect the impurities in the films. In some of the deposits, about 1% of Fe and oxygen were found. The areal density ( $\text{gm}^2/\text{m}^2$ ) and the elemental composition of the SiC films were obtained from the simulation of the elastic region of the spectra. An empirical estimation of the error in the areal density and the composition of the films are approximately  $\pm 5\%$

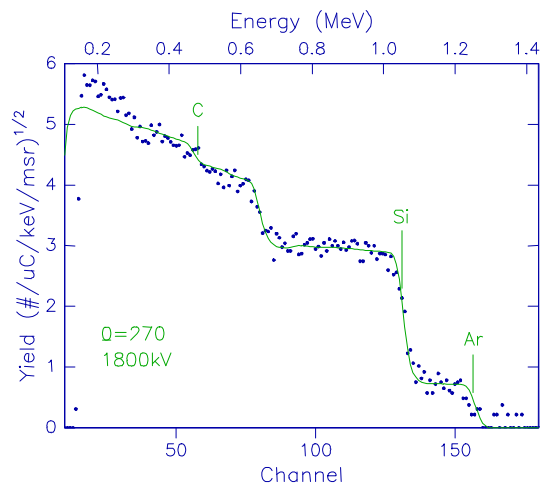


Fig. 1. Typical spectrum from RBS for SiC

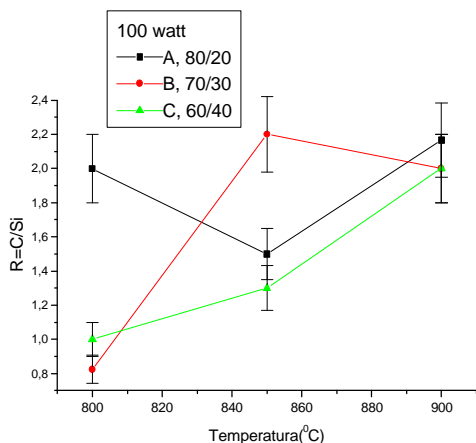


Fig.2. Shows the variation of R with substrate temperature  $T_s$  at 100 Watt of RF-Power. The curves A, B and C indicate R versus  $T_s$  variation at a fixed composition 80/20, 70/30 and 60/40 of Ar to  $\text{C}_2\text{H}_4$  respectively

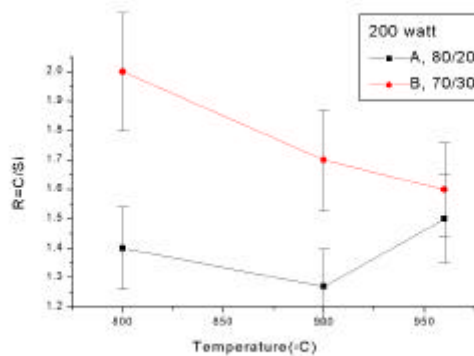


Fig. 3. The variation of R vs  $T_s$  for RF-power=200 watt. The curves A and B represent the  $\text{Ar}/\text{C}_2\text{H}_4=80/20$  and  $70/30$  respectively.

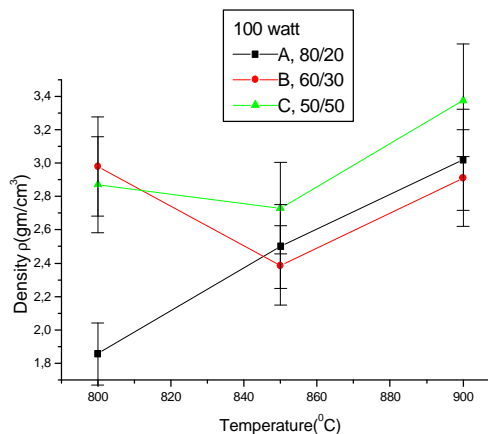


Fig.4. The variation of  $\rho(\text{g}/\text{cm}^3)$  vs  $T_s$  at RF-Power=100 watt. The curves A, B and C show  $\text{Ar}/\text{C}_2\text{H}_4=80/20$ ,  $60/40$  and  $50/50$  respectively

Curve A shows that R remains, almost, constant with increasing temperature. The curves B and C show that R increases from the stoichiometric value with  $T_s$  smoothly. The R versus  $T_s$  variation for 200 Watt of RF-Power is shown in figure 3 where the curves A and B represent this variation at a gas composition of  $\text{Ar}/\text{C}_2\text{H}_4 = 80/20$  and  $70/30$  respectively. From these curves, it is observed that there is almost no change in R when temperature is increased

The density  $\rho(\text{gm}/\text{cm}^3)$  has also been calculated by using the areal density and the thickness of the films. Figure 4 shows the variation of  $\rho$  versus  $T_s$  from  $800^\circ\text{C}$ - $950^\circ\text{C}$  at RF-Power of 100 Watt where the curves A, B and C represent this variation at fixed concentration of  $\text{CH}_4 = 20\%$ ,  $40\%$  and  $50\%$  respectively. It is observed that there is an increasing trend in the variation of  $\rho$  for the curve A while the curve B decreases with increasing  $T_s$ .

On the other hand, there is no variation in  $\rho$  with temperature for the curve C. The  $\rho$  versus  $T_s$  variation for RF-power of 200 Watt is shown in the figure 5 where the curves A, B, C and D represent the density curves at fixed concentration of  $CH_4=20\%$ ,  $30\%$ ,  $40\%$  and  $50\%$  respectively. The density curves A, C and D have increasing trend of the variation of  $\rho$  with  $T_s$  while in the curve B,  $\rho$  remains constant with temperature.

The deposition rate DR is also an important parameter in the preparation of SiC thin films which helps to explain the optical and structural properties of a-SiC films. According to the DR curves, it is observed that DR decreases with increasing  $T_s$  for 100 watt of RF power, while for 200 watt of RF power, DR increases with the increase of  $T_s$ . It has also been observed that the refractive index,  $n$ , has almost same trend of variation with temperature for 100 watt and 200 watt of RF power i.e.  $n$  decreases with the increase of  $T_s$ .

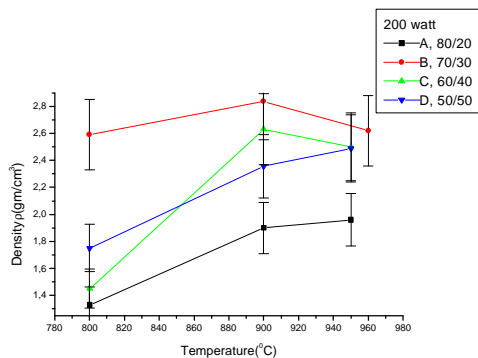


Fig.5. The density  $\rho$  vs  $T_s$  at RF-power=200 watt. The curves A,B and C represent the Ar/ $CH_4=80/20$ ,  $70/30$ ,  $60/40$  and  $50/50$  respectively.

Figure 6 shows the variation of  $n$  with Ar/ $CH_4$  composition at fixed value of the substrate temperature where the curves  $P_1$  and  $P_2$  represent the variation for 200 watt and 100 watt of RF power respectively. According to this, it is observed that both curves demonstrate an opposite trend of variation of  $n$  with the concentration of  $CH_4$  which means that  $n$  decreases for 100 watt while it increases for 200 watt of RF power.

#### 4. Discussion

This study has demonstrated various interesting aspects related to the preparation of a-SiC thin films prepared by RF-RMS technique. It is observed that the SiC film properties mostly depend upon the decomposition of  $CH_4$  molecules and the bombardment assisted chemical reactions on the surface of the Si target and on the substrate[6]. It has been seen that the deposition rate and consequently the film properties largely depends upon RF-Power. The glow-discharge plasma conditions can be chosen in such a way that an intense decomposition of  $CH_4$  molecules occurs in the magnetron plasma.

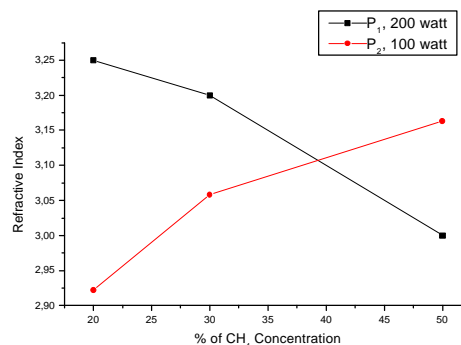


Fig.6. The variation of refractive index,  $n$ , vs  $CH_4$  concentration.

The hydrocarbon fragments created in this manner are known to have a high sticking probability on the walls of the reaction chamber even without a concomitant flux of atoms (Si in this case) sputtered from the target. This implies that the consumption of the hydrocarbon gas will not only be dependent on the amount of the sputtered atoms, the pumping speed and pyrolysis on the heated substrate surface but also on the degree of decomposition in the plasma. The latter can be expected to play a crucial role in decreasing the temperatures. However, in order to obtain a detailed understanding of the mechanism of SiC film growth by the RMS technique, it is essential to understand the mechanism of plasma decomposition of the hydrocarbon molecules and their chemisorption behaviour on the growing film surface.

DR is an important parameter, which largely depends upon the decomposition of  $CH_4$  molecules for the preparation of SiC films by RF-RMS technique. From the results, it is clearly found that DR is high for higher RF power which means that the decomposition of  $CH_4$  molecules is high for higher power. But the density curves show that at lower DR, high density SiC were obtained which is in good agreement with the bulk value of the density of the SiC( $3.2 \text{ gm/cm}^3$ ). Moreover, at lower RF power stoichiometric films can be obtained at higher  $CH_4$  concentration and at lower substrate temperature. This means that the decomposition of  $CH_4$  molecules and the bombardment assisted chemical reactions are sufficient to form the good quality a-SiC films at lower RF power.

#### 5. Conclusion

SiC films have been prepared by using the RF magnetron sputtering technique by changing the deposition parameters over a wide range and several characterization techniques have been used to optimise the quality of the films. It is to be concluded that DR is low but dense and stoichiometric a-SiC films can be obtained at lower RF-power. This signifies that at lower RF-Power but higher  $CH_4$  concentration, sufficient number of carbon radicals are formed and participate in the bombardment assisted chemical reactions on the surface of the target and the substrate to form good quality SiC films.

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